47. The bond-ply material of claim 46, wherein the conductive paste comprises a plurality of inorganic particles in a organic medium.

## **IN THE SPECIFICATION**

Insert the following before "Field of the Invention":

This application is a divisional of allowed application Serial Number 09/826,718, filed April 4, 2001.

## **REMARKS**

No new matter was added by this preliminary amendment.

Please use 30-4949 DIV2 - 4960 as the docket number for this application.

## **REQUEST FOR ALLOWANCE**

Claims 34-47 are pending in this application. The applicants request allowance of all pending claims.

Respectfully submitted,

Mingham McCutchen LLP

Dated: November 17, 2003

Sandra P. Thompson

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